

1934347-1 ✓ ACTIVE

Z-PACK | Z-PACK TinMan

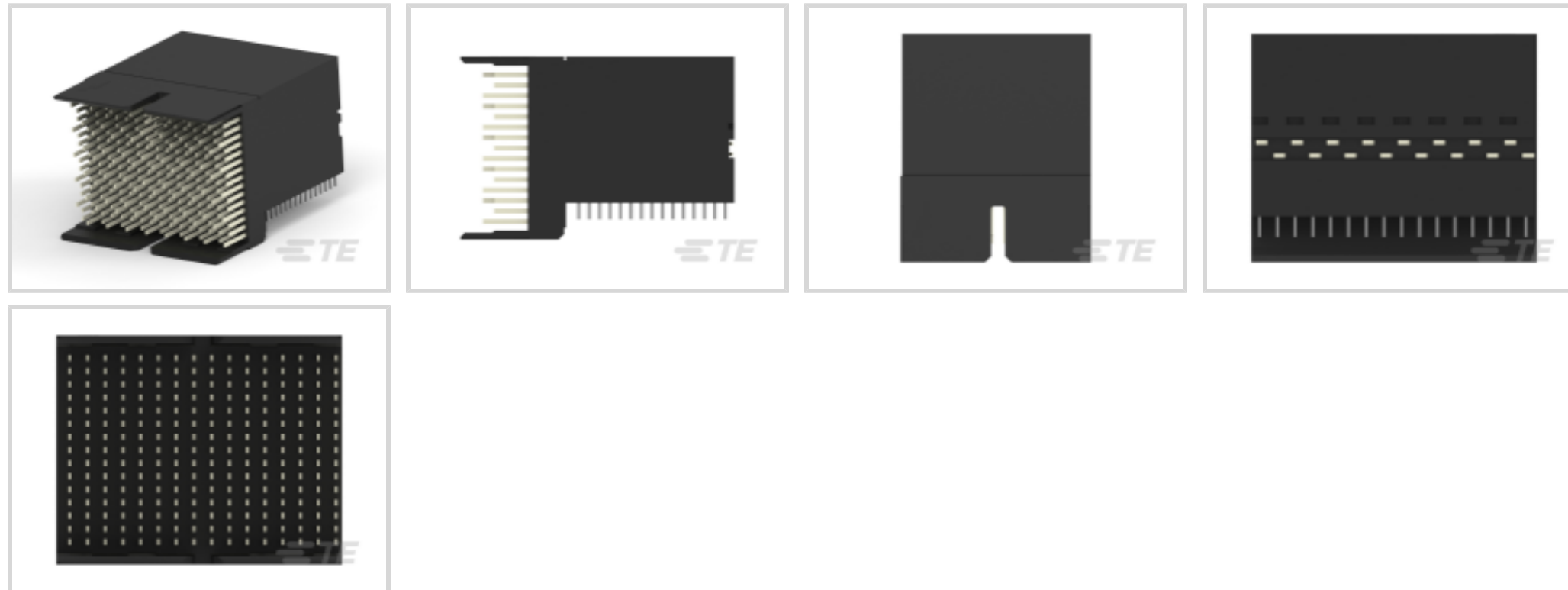
TE Internal #: 1934347-1

High Speed Backplane Connectors, 240 Position, Mating Alignment, Guide Slot Mating Alignment Type, 15 Row, 16 Column, PCB Mount Header, Z-PACK TinMan

[View on TE.com >](#)



Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Connector System: **Board-to-Board**

Number of Positions: **240**

Row-to-Row Spacing: **1.4 mm [.055 in]**

Mating Alignment: **With**

Mating Alignment Type: **Guide Slot**

Features

Product Type Features

Backplane Module Type	Center
Signal Arrangement	Differential
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Partially Shrouded
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Pairs per Column	5
Number of Pairs	80
Stackable	No
Number of Signal Positions	160
Backplane Architecture	Co-Planar
Number of Positions	240
Number of Rows	15



Number of Columns	16
PCB Mount Orientation	Right Angle

Electrical Characteristics

Impedance	100 Ω
Operating Voltage	250 VAC

Signal Characteristics

Differential Impedance	100 Ω
Number of Differential Pairs per Column	5
Data Rate	10 Gb/s

Body Features

Shield Material	Phosphor Bronze
Primary Product Color	Black

Contact Features

Contact Mating Area Length	6 mm[.236 in]
PCB Contact Termination Area Plating Material Thickness	.5 μm [20 μin]
Contact Type	Pin
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Rectangular
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	.5 A

Termination Features

Termination Post & Tail Length	2.2 mm[.087 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

Mechanical Attachment

Guide Hardware	Without
Mating Retention	Without
PCB Mount Alignment	Without
PCB Mount Retention	With
PCB Mount Retention Type	Action/Compliant Tail
Mating Alignment	With



Mating Alignment Type	Guide Slot
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Connector Mounting Type	Board Mount
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Housing Features

Number of Shrouded Sides	2
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End Wall Location	Open
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Housing Material	LCP (Liquid Crystal Polymer)
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Centerline (Pitch)	1.9 mm[.075 in]
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Dimensions

Connector Length	30.55 mm
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Connector Height	24.4 mm
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Connector Width	36.61 mm
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PCB Thickness (Recommended)	1.57 mm[.062 in]
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PCB Hole Diameter	.47 mm
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Row-to-Row Spacing	1.4 mm[.055 in]
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Usage Conditions

Operating Temperature Range	-65 – 90 °C[-85 – 194 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

Agency/Standard	UL
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Approved Standards	UL E28476
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UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Method	Box & Tube, Tube
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Compliant
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China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
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EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235)
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Candidate List Declared Against: JUNE
2023 (235)
Does not contain REACH SVHC

Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

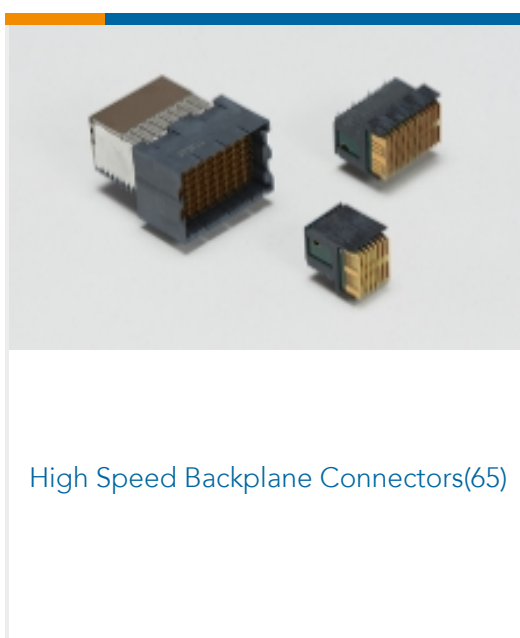
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Also in the Series | Z-PACK TinMan



Customers Also Bought



Documents

Product Drawings

[TinMan R/A Header Assy 5x16 Open](#)

English

CAD Files

Customer View Model

[ENG_CVM_CVM_1934347-1_B.3d_stp.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1934347-1_B.2d_dxf.zip](#)

English

[3D PDF](#)

3D

Customer View Model

[ENG_CVM_CVM_1934347-1_B.3d_igs.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[High Speed Backplane Connectors catalog - Z-PACK TinMan High Speed, High Density Backplane Connector](#)

English

Product Specifications

[Application Specification](#)

English